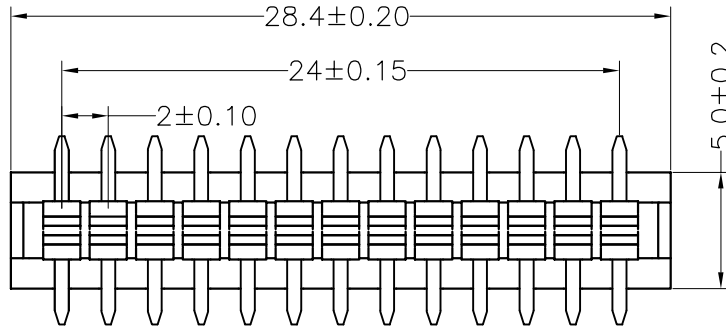


HSF RoHS

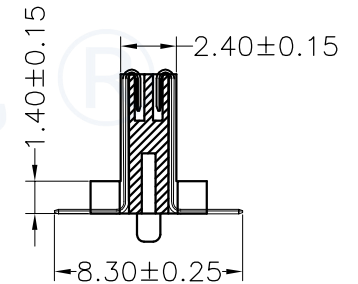
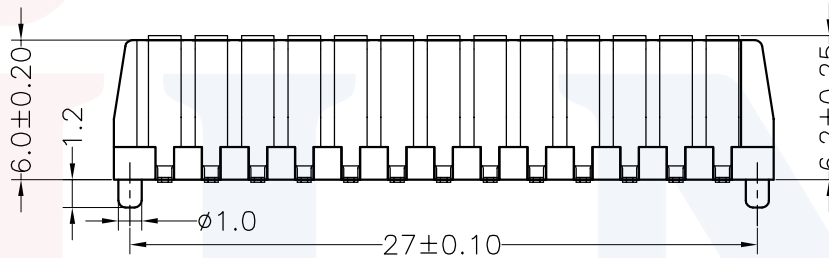
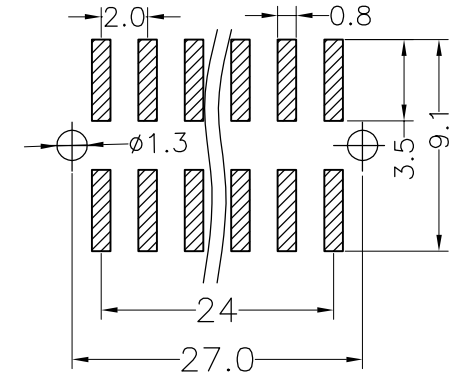
SPECIFICATIONS

Rated Current:1.5AMP
 Contact Resistance:20mΩ Max
 Withstand Voltage:500V AC/DC
 Insulation Resistance:500MΩ Min
 Operation Temperature:-40°C to +105°C

Contact Material:Phosphor bronze
 Contact Plating:Au or Sn Over Ni
 Insulator Material:Polyester(UL94V-0)
 Standard: PA9T
 Max.Processing Temp: 230°C for 30-60 seconds
 260°C for 10 seconds



Recommended P.C.B Layout(Top Side) (PCB BOARD TOLERANCE±0.05)

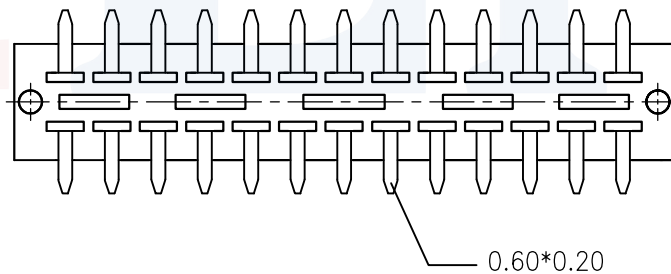


Ordering Information

4400- 2 13 M G1 M E B W 01

No.of Pins
2x13P

Contact Plating
 G0:Gold Flash
 G1:1U" Gold
 G2:2U" Gold
 G3:3U" Gold
 G4:5U" Gold
 G5:10U" Gold



		OPERATION		DRAW	JinChengXin	17.11.24	SCALE	FIT	JILN 深圳市锦凌电子有限公司 SHENZHEN JINLING ELECTRONIC CO.,LTD Tel: 86-755-2997-5806/5802 Fax: 86-755-2997-5992	
		X.X	±0.30				UNIT	mm		
		X.XX	±0.20	CHECK			SIZE	A4	PART NO.	4400-213MG1MEBW01
		X.XXX	±0.10		SHEET	1/1	TITLE:	2.0金手指连接器 2X13P 公座 SMT 带柱		
REV	DATE	MODIFICATION DESCRIPTION		CHANGE	APPROVE	PROJ.				

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